

# LM4810 Boomer® Audio Power Amplifier Series

## Dual 105mW Headphone Amplifier with Active-High Shutdown Mode

### General Description

The LM4810 is a dual audio power amplifier capable of delivering 105mW per channel of continuous average power into a 16Ω load with 0.1% (THD+N) from a 5V power supply.

Boomer audio power amplifiers were designed specifically to provide high quality output power with a minimal amount of external components. Since the LM4810 does not require bootstrap capacitors or snubber networks, it is optimally suited for low-power portable systems.

The unity-gain stable LM4810 can be configured by external gain-setting resistors.

The LM4810 features an externally controlled, active-high, micropower consumption shutdown mode, as well as an internal thermal shutdown protection mechanism.

### Key Specifications

- THD+N at 1kHz, 105mW continuous average power into 16Ω 0.1% (typ)

- THD+N at 1kHz, 70mW continuous average power into 32Ω 0.1% (typ)
- Shutdown Current 0.4μA (typ)

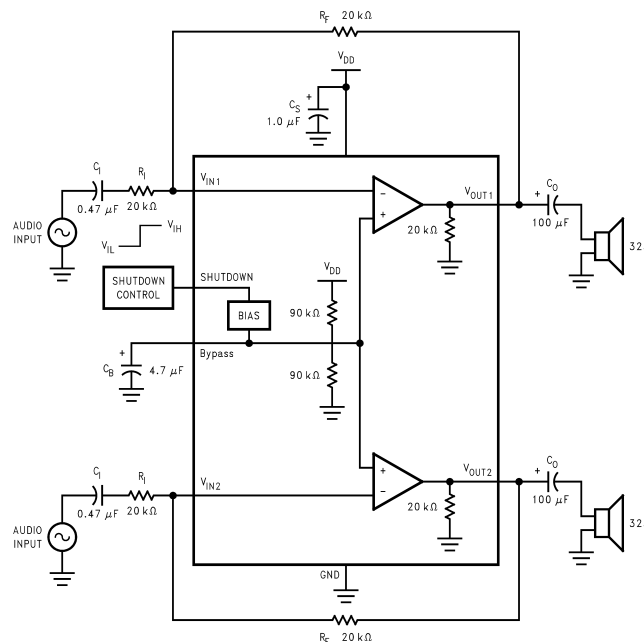
### Features

- Active-high shutdown mode
- LLP, MSOP, and SO surface mount packaging
- "Click and Pop" suppression circuitry
- Low shutdown current
- No bootstrap capacitors required
- Unity-gain stable

### Applications

- Cellular Phones
- Personal Computers
- Microphone Preamplifier
- PDA's

### Typical Application



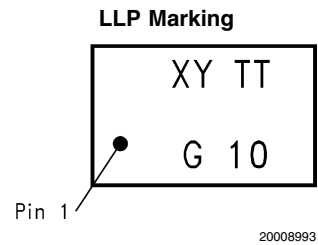
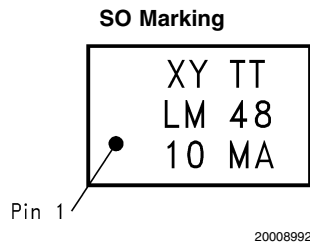
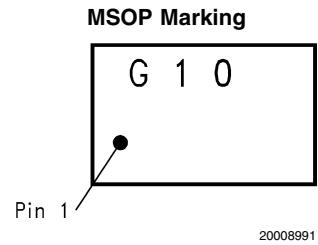
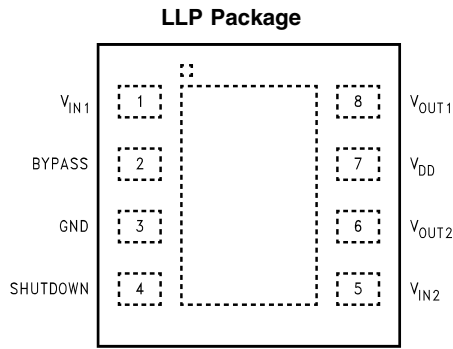
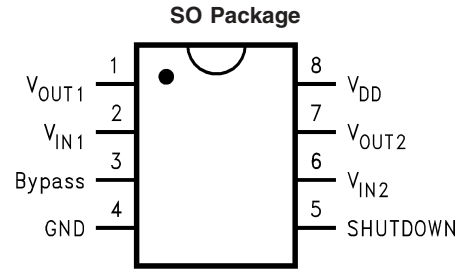
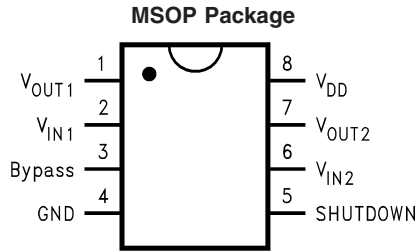
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\*Refer to the **Application Information** Section for information concerning proper selection of the input and output coupling capacitors.

**FIGURE 1. Typical Audio Amplifier Application Circuit**

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# Connection Diagrams



**Absolute Maximum Ratings** (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

|  |                 |
|--|-----------------|
| Supply Voltage                         | 6.0V            |
| Storage Temperature                    | -65°C to +150°C |
| ESD Susceptibility (Note 4)            | 3.5kV           |
| ESD Machine Model (Note 8)             | 250V            |
| Junction Temperature (T <sub>J</sub> ) | 150°C           |
| Soldering Information (Note 1)         |                 |
| Small Outline Package                  |                 |
| Vapor Phase (60 sec.)                  | 215°C           |
| Infrared (15 sec.)                     | 220°C           |
| Thermal Resistance                     |                 |
| θ <sub>JA</sub> (SO)                   | 170°C/W         |

|                        |                   |
|------------------------|-------------------|
| θ <sub>JC</sub> (SO)   | 35°C/W            |
| θ <sub>JA</sub> (MSOP) | 210°C/W           |
| θ <sub>JC</sub> (MSOP) | 56°C/W            |
| θ <sub>JA</sub> (LLP)  | 117°C/W (Note 9)  |
| θ <sub>JA</sub> (LLP)  | 150°C/W (Note 10) |
| θ <sub>JC</sub> (LLP)  | 15°C/W            |

**Operating Ratings** (Note 2)

Temperature Range

$$T_{MIN} \leq T_A \leq T_{MAX} \quad -40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$$

$$\text{Supply Voltage (V}_{CC}) \quad 2.0\text{V} \leq V_{CC} \leq 5.5\text{V}$$

**Note 1:** See AN-450 "Surface Mounting and their Effects on Product Reliability" for other methods of soldering surface mount devices.

**Electrical Characteristics** (Notes 2, 3)

The following specifications apply for V<sub>DD</sub> = 5V unless otherwise specified, limits apply to T<sub>A</sub> = 25°C.

| Symbol            | Parameter                    | Conditions   | LM4810       |                       | Units (Limits) |
|-------------------|------------------------------|--|--------------|-----------------------|----------------|
|                   |                              |  | Typ (Note 5) | Limit (Note 7)        |                |
| V <sub>DD</sub>   | Supply Voltage               |  |              | 2.0                   | V (min)        |
|                   |                              |  |              | 5.5                   | V (max)        |
| I <sub>DD</sub>   | Supply Current               | V <sub>IN</sub> = 0V, I <sub>O</sub> = 0A  | 1.3          | 3                     | mA(max)        |
| I <sub>SD</sub>   | Shutdown Current             | V <sub>IN</sub> = 0V, V <sub>SHUTDOWN</sub> = V <sub>DD</sub>  | 0.4          | 2                     | μA(max)        |
| V <sub>OS</sub>   | Output Offset Voltage        | V <sub>IN</sub> = 0V   | 4.0          | 50                    | mV(max)        |
| P <sub>O</sub>    | Output Power                 | THD+N = 0.1%, f = 1kHz   |              |                       |                |
|                   |                              | R <sub>L</sub> = 16Ω   | 105          |                       | mW             |
|                   |                              | R <sub>L</sub> = 32Ω   | 70           | 65                    | mW(min)        |
| THD+N             | Total Harmonic Distortion    | P <sub>O</sub> = 50mW, R <sub>L</sub> = 32Ω<br>f = 20Hz to 20kHz   | 0.3          |                       | %              |
| Crosstalk         | Channel Separation           | R <sub>L</sub> = 32Ω; P <sub>O</sub> = 70mW  | 70           |                       | dB             |
| PSRR              | Power Supply Rejection Ratio | C <sub>B</sub> = 1.0μF; V <sub>RIPPLE</sub> = 200mV <sub>PP</sub> ,<br>f = 1kHz; Input terminated into 50Ω | 70           |                       | dB             |
| V <sub>SDIH</sub> | Shutdown Voltage Input High  |  |              | 0.8 x V <sub>DD</sub> | V (min)        |
| V <sub>SDIL</sub> | Shutdown Voltage Input Low   |  |              | 0.2 x V <sub>DD</sub> | V (max)        |

**Electrical Characteristics** (Notes 2, 3)

The following specifications apply for V<sub>DD</sub> = 3.3V unless otherwise specified, limits apply to T<sub>A</sub> = 25°C.

| Symbol          | Parameter                 | Conditions   | LM4810       |                | Units (Limits) |
|-----------------|---------------------------|--|--------------|----------------|----------------|
|                 |                           |  | Typ (Note 5) | Limit (Note 7) |                |
| I <sub>DD</sub> | Supply Current            | V <sub>IN</sub> = 0V, I <sub>O</sub> = 0A                        | 1.0          |                | mA             |
| I <sub>SD</sub> | Shutdown Current          | V <sub>IN</sub> = 0V, V <sub>SHUTDOWN</sub> = V <sub>DD</sub>    | 0.4          |                | μA             |
| V <sub>OS</sub> | Output Offset Voltage     | V <sub>IN</sub> = 0V   | 4.0          |                | mV             |
| P <sub>O</sub>  | Output Power              | THD+N = 0.1%, f = 1kHz   |              |                |                |
|                 |                           | R <sub>L</sub> = 16Ω   | 40           |                | mW             |
|                 |                           | R <sub>L</sub> = 32Ω   | 28           |                | mW             |
| THD+N           | Total Harmonic Distortion | P <sub>O</sub> = 25mW, R <sub>L</sub> = 32Ω<br>f = 20Hz to 20kHz | 0.4          |                | %              |
| Crosstalk       | Channel Separation        | R <sub>L</sub> = 32Ω; P <sub>O</sub> = 25mW                      | 70           |                | dB             |

**Electrical Characteristics** (Notes 2, 3) (Continued)

The following specifications apply for  $V_{DD} = 3.3V$  unless otherwise specified, limits apply to  $T_A = 25^\circ C$ .

| Symbol     | Parameter                    | Conditions  | LM4810       |                     | Units (Limits) |
|------------|------------------------------|---|--------------|---------------------|----------------|
|            |                              |   | Typ (Note 5) | Limit (Note 7)      |                |
| PSRR       | Power Supply Rejection Ratio | $C_B = 1.0\mu F$ ; $V_{ripple} = 200mV_{PP}$ ,<br>$f = 1kHz$ ; Input terminated into $50\Omega$ | 70           |                     | dB             |
| $V_{SDIH}$ | Shutdown Voltage Input High  |   |              | $0.8 \times V_{DD}$ | V (min)        |
| $V_{SDIL}$ | Shutdown Voltage Input Low   |   |              | $0.2 \times V_{DD}$ | V (max)        |

**Electrical Characteristics** (Notes 2, 3)

The following specifications apply for  $V_{DD} = 2.6V$  unless otherwise specified, limits apply to  $T_A = 25^\circ C$ .

| Symbol     | Parameter                    | Conditions  | LM4810       |                     | Units (Limits) |
|------------|------------------------------|---|--------------|---------------------|----------------|
|            |                              |   | Typ (Note 5) | Limit (Note 7)      |                |
| $I_{DD}$   | Supply Current               | $V_{IN} = 0V$ , $I_O = 0A$  | 0.9          |                     | mA             |
| $I_{SD}$   | Shutdown Current             | $V_{IN} = 0V$ , $V_{SHUTDOWN} = V_{DD}$   | 0.2          |                     | $\mu A$        |
| $V_{OS}$   | Output Offset Voltage        | $V_{IN} = 0V$   | 4.0          |                     | mV             |
| $P_O$      | Output Power                 | THD+N = 0.1%, $f = 1kHz$  |              |                     |                |
|            |                              | $R_L = 16\Omega$  | 20           |                     | mW             |
|            |                              | $R_L = 32\Omega$  | 16           |                     | mW             |
| THD+N      | Total Harmonic Distortion    | $P_O = 15mW$ , $R_L = 32\Omega$<br>$f = 20Hz$ to $20kHz$  | 0.6          |                     | %              |
| Crosstalk  | Channel Separation           | $R_L = 32\Omega$ ; $P_O = 15mW$   | 70           |                     | dB             |
| PSRR       | Power Supply Rejection Ratio | $C_B = 1.0\mu F$ ; $V_{ripple} = 200mV_{PP}$ ,<br>$f = 1kHz$ ; Input terminated into $50\Omega$ | 70           |                     | dB             |
| $V_{SDIH}$ | Shutdown Voltage Input High  |   |              | $0.8 \times V_{DD}$ | V (min)        |
| $V_{SDIL}$ | Shutdown Voltage Input Low   |   |              | $0.2 \times V_{DD}$ | V (max)        |

**Note 2:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur.

**Note 3:** All voltages are measured with respect to the ground pin, unless otherwise specified.

**Note 4:** Human body model, 100pF discharged through a 1.5k $\Omega$  resistor.

**Note 5:** Typical specifications are specified at +25 $^\circ C$  and represent the most likely parametric norm.

**Note 6:** Tested limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

**Note 7:** Datasheet max/min specification limits are guaranteed by design, test, or statistical analysis.

**Note 8:** Machine Model ESD test is covered by specification EIAJ IC-121-1981. A 200pF cap is charged to the specified voltage, then discharged directly into the IC with no external series resistor (resistance of discharge path must be under 50 $\Omega$ ).

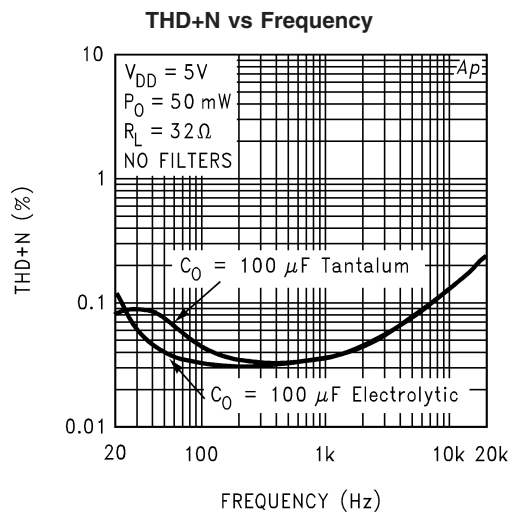
**Note 9:** The given  $\theta_{JA}$  is for an LM4810 packaged in an LDA08B with the Exposed-Dap soldered to a printed circuit board copper pad with an area equivalent to that of the Exposed-Dap itself.

**Note 10:** The given  $\theta_{JA}$  is for an LM4810 packaged in an LDA08B with the Exposed-Dap not soldered to any circuit board copper.

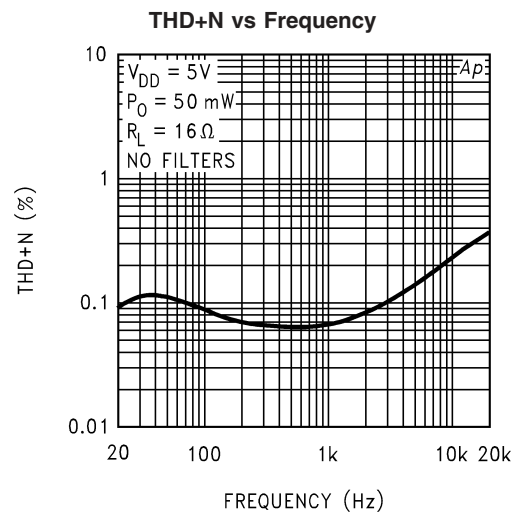
## External Components Description (Figure 1)

| Components | Functional Description  |
|------------|---|
| 1. $R_i$   | The inverting input resistance, along with $R_f$ , set the closed-loop gain. $R_i$ , along with $C_i$ , form a high pass filter with $f_c = 1/(2\pi R_i C_i)$ .   |
| 2. $C_i$   | The input coupling capacitor blocks DC voltage at the amplifier's input terminals. $C_i$ , along with $R_i$ , create a highpass filter with $f_c = 1/(2\pi R_i C_i)$ . Refer to the section, <b>Selecting Proper External Components</b> , for an explanation of determining the value of $C_i$ . |
| 3. $R_f$   | The feedback resistance, along with $R_i$ , set closed-loop gain.   |
| 4. $C_S$   | This is the supply bypass capacitor. It provides power supply filtering. Refer to the <b>Application Information</b> section for proper placement and selection of the supply bypass capacitor.   |
| 5. $C_B$   | This is the BYPASS pin capacitor. It provides half-supply filtering. Refer to the section, <b>Selecting Proper External Components</b> , for information concerning proper placement and selection of $C_B$ .   |
| 6. $C_O$   | This is the output coupling capacitor. It blocks the DC voltage at the amplifier's output and forms a high pass filter with $R_L$ at $f_o = 1/(2\pi R_L C_O)$   |

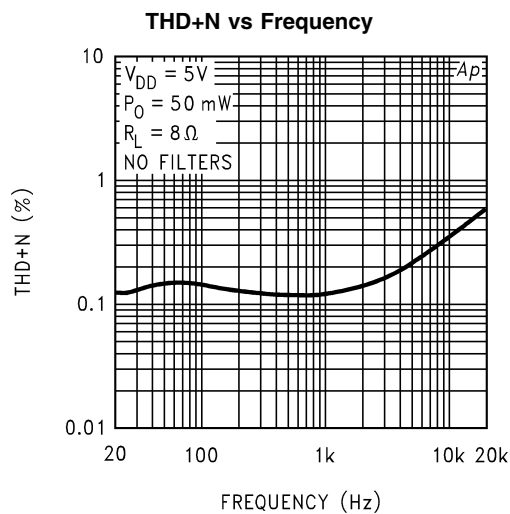
## Typical Performance Characteristics



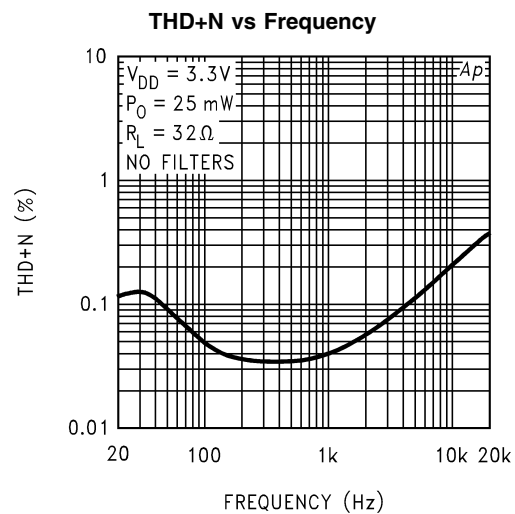
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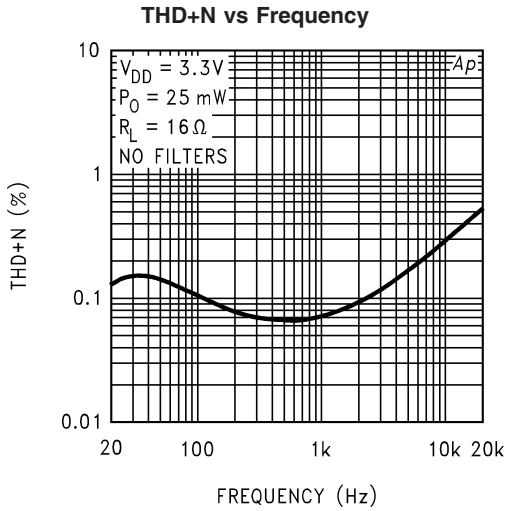


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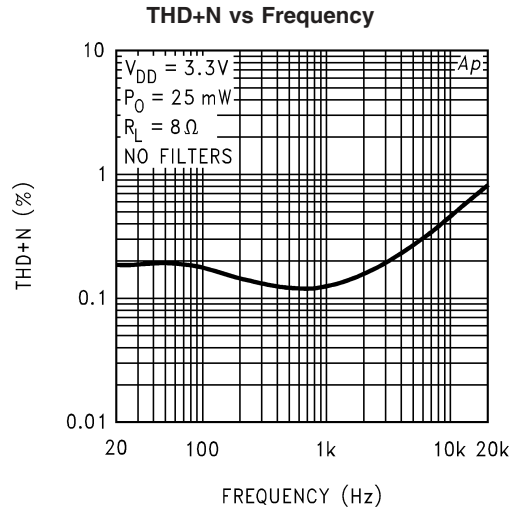


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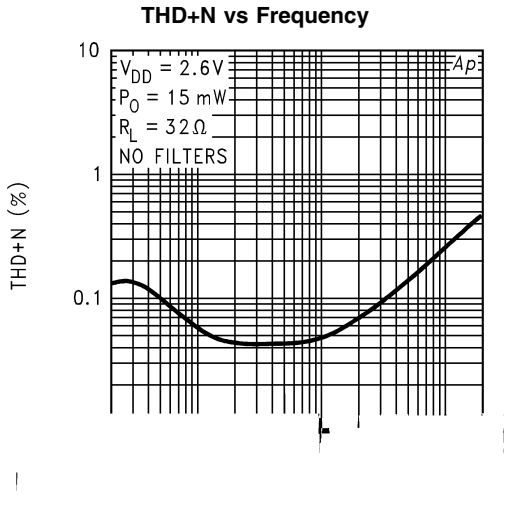
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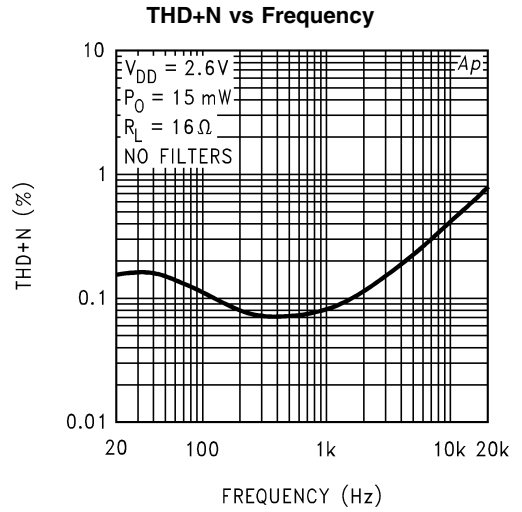
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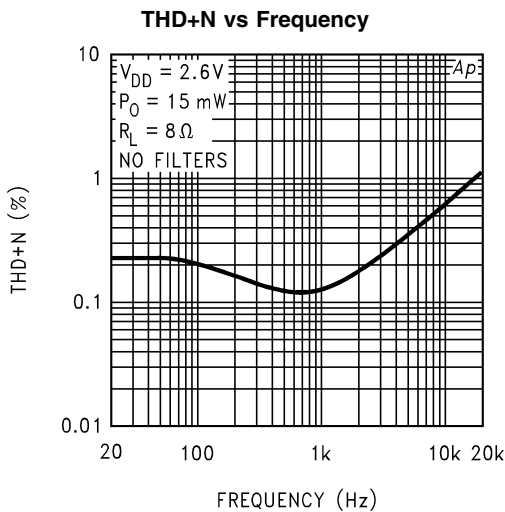
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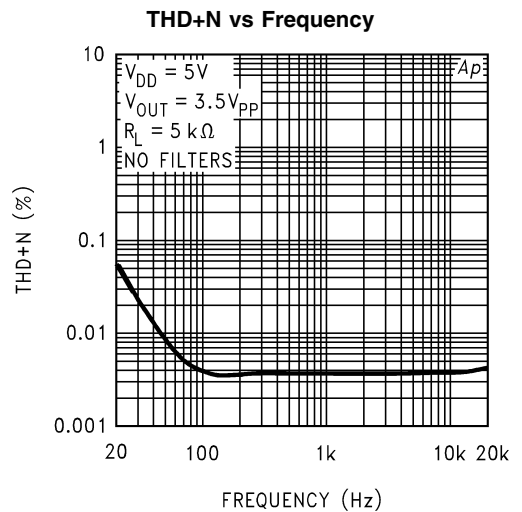
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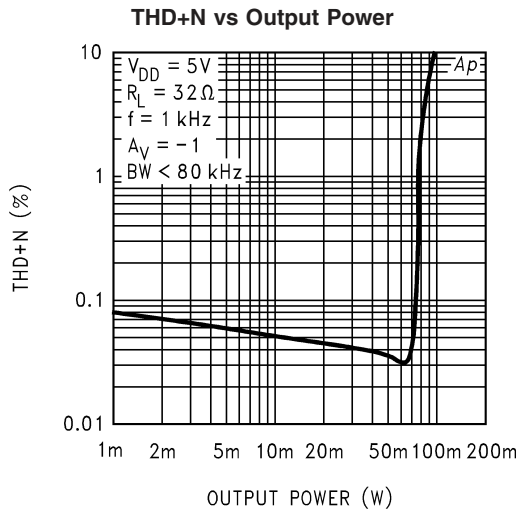


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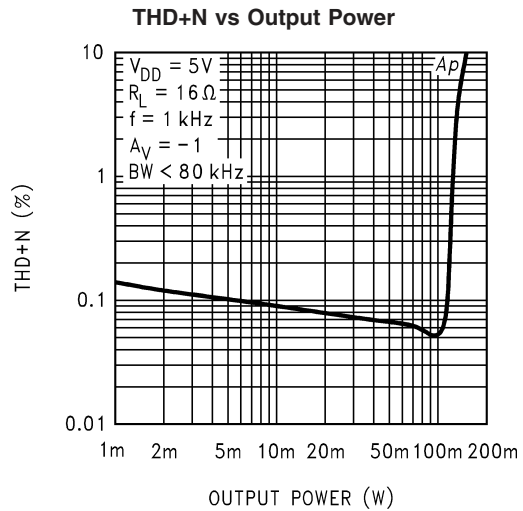


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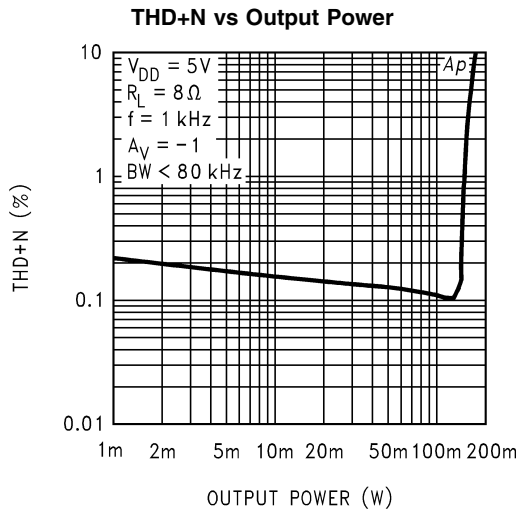
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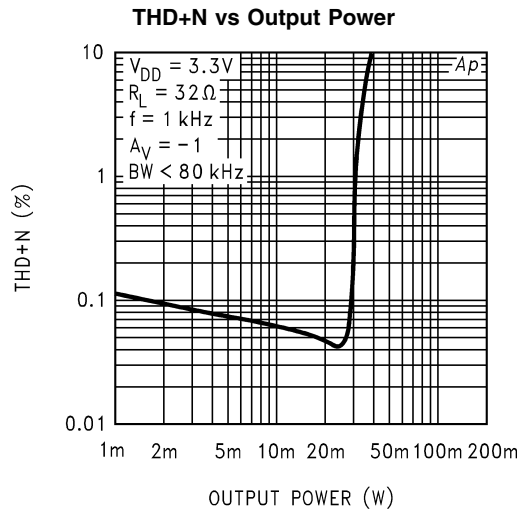
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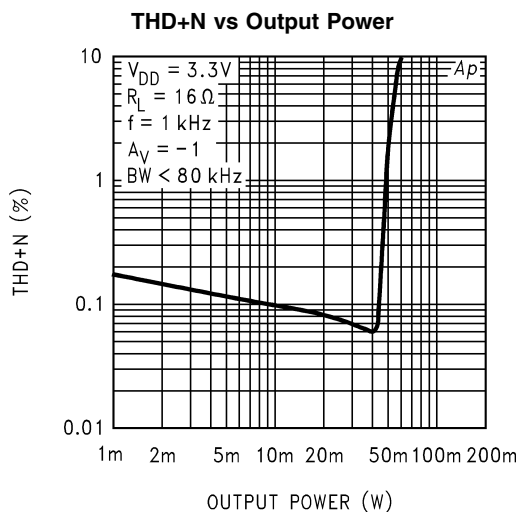
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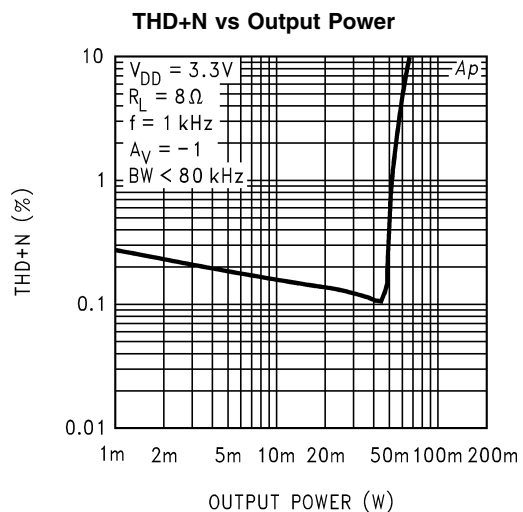
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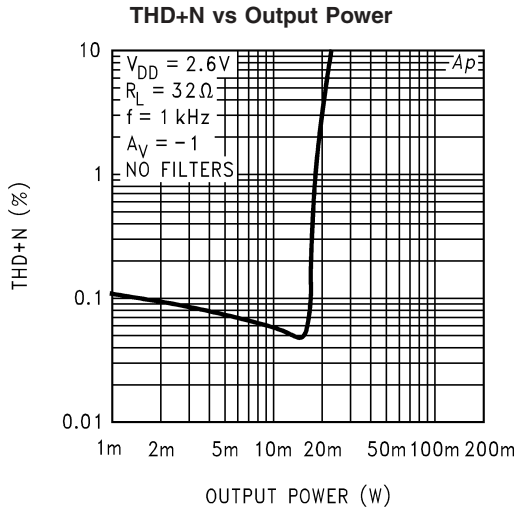


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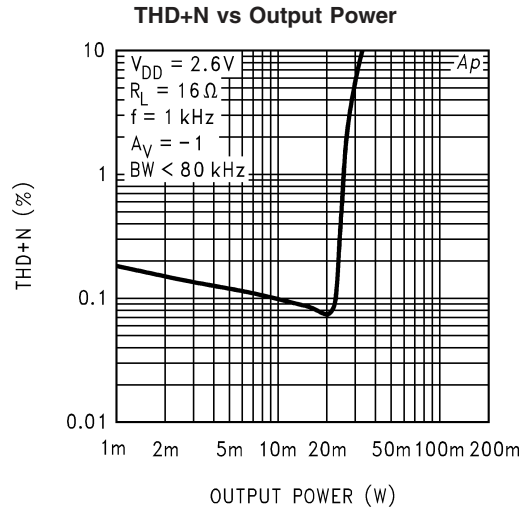


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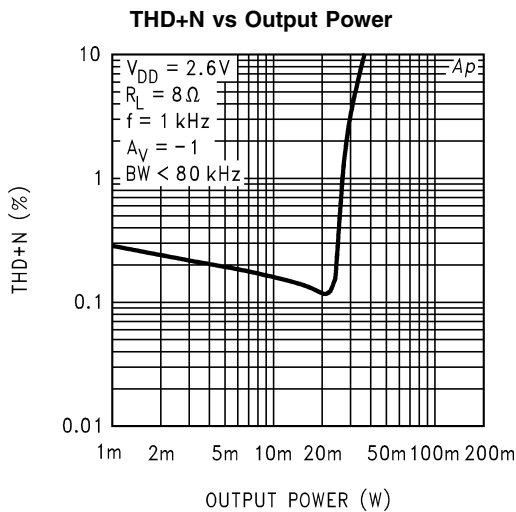
Typical Performance Characteristics (Continued)



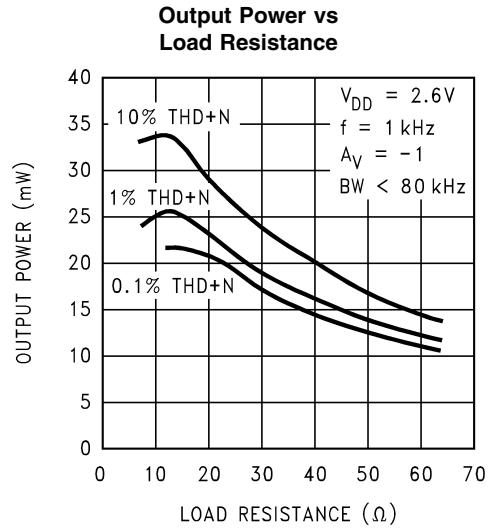
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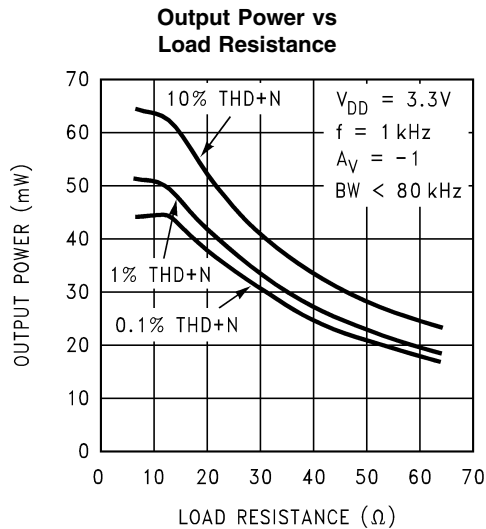
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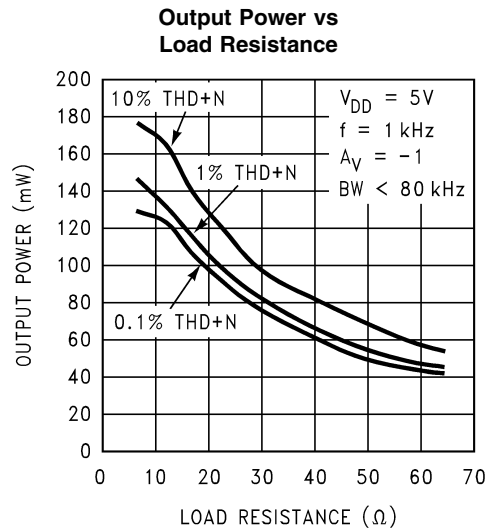
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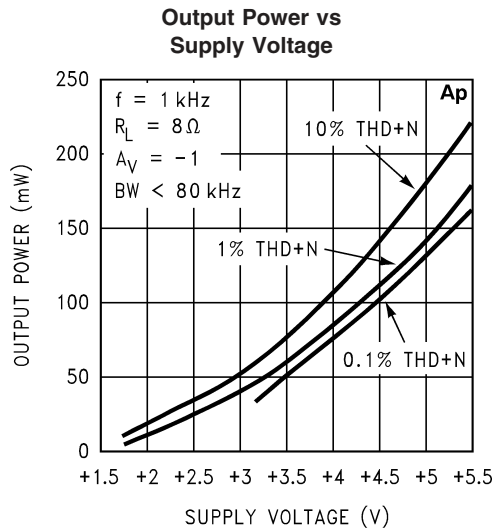
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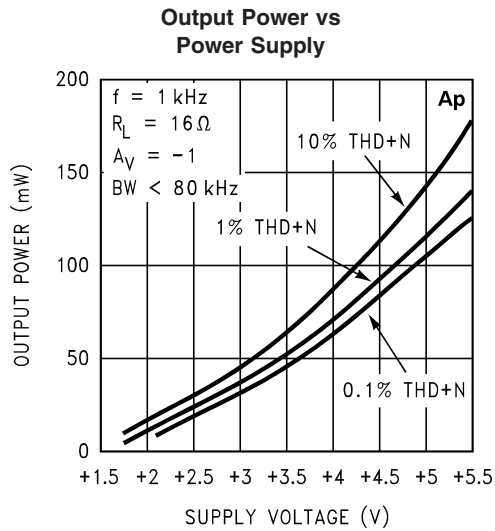
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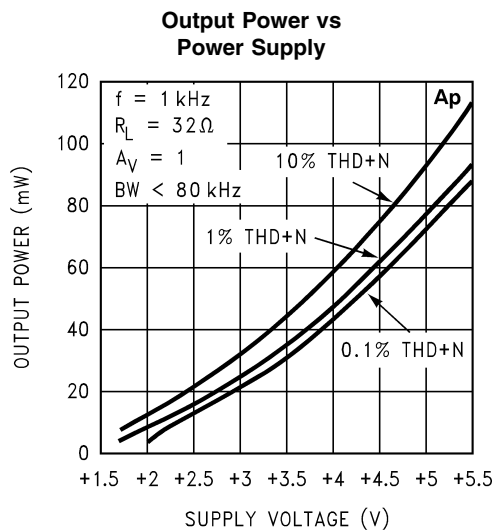
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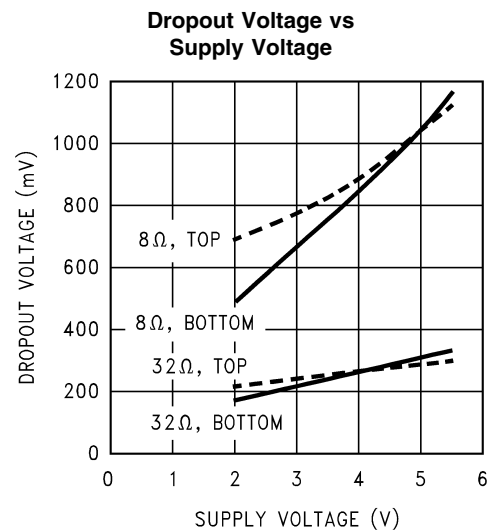
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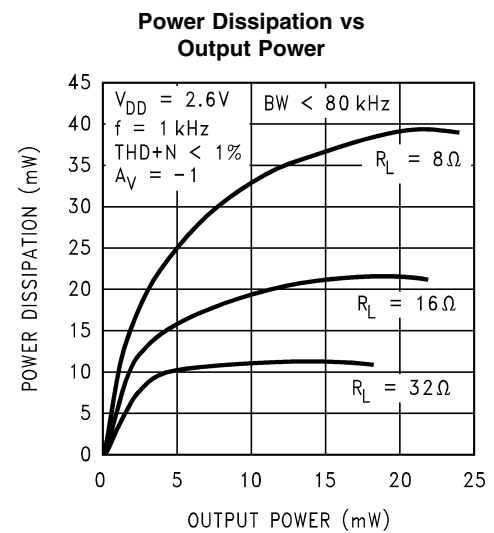
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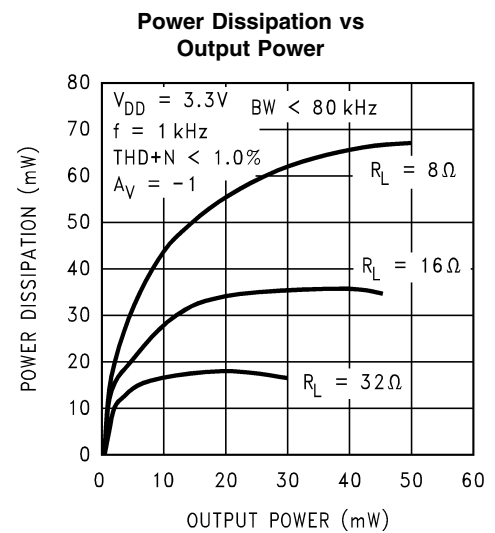
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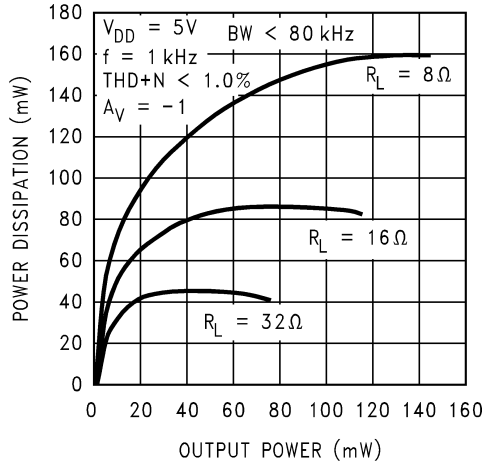
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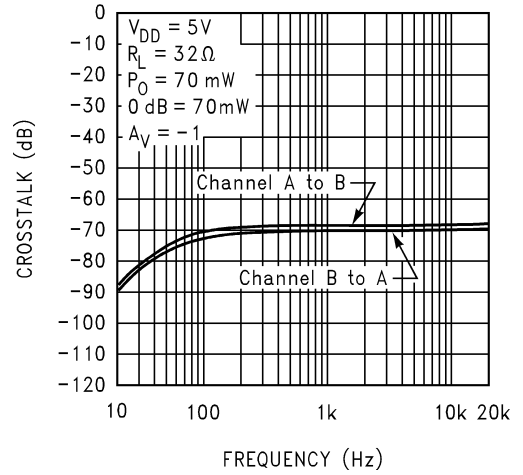
# Typical Performance Characteristics (Continued)

**Power Dissipation vs Output Power**



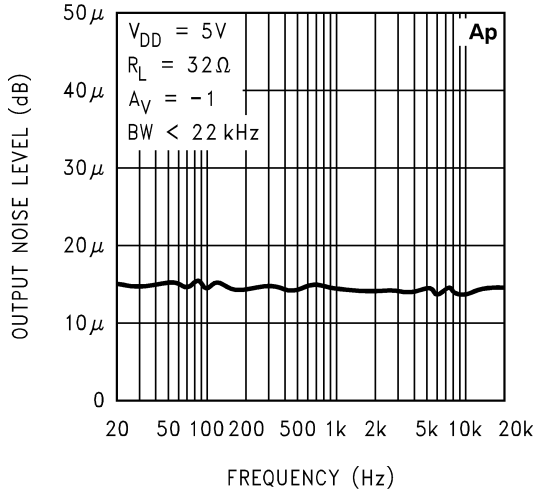
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**Channel Separation**



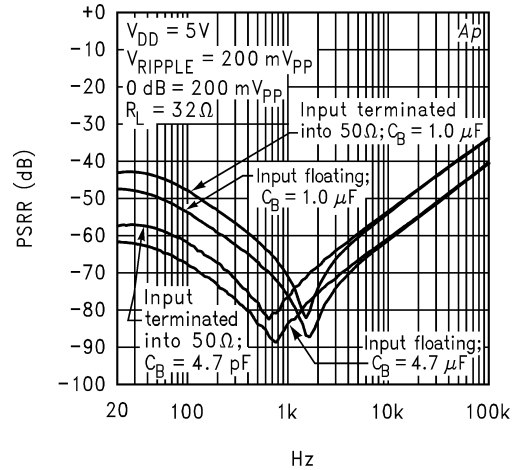
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**Noise Floor**



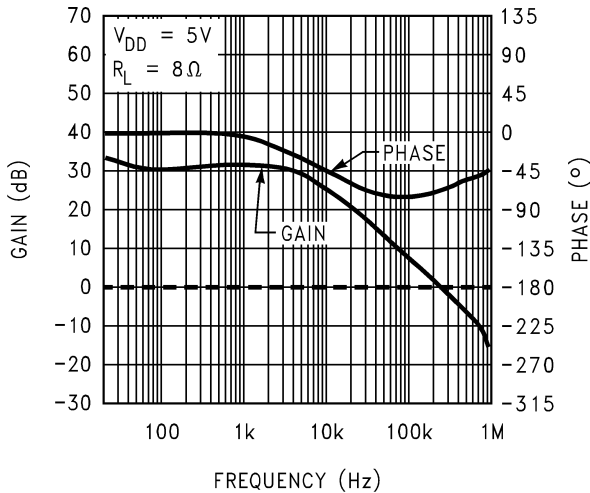
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**Power Supply Rejection Ratio**



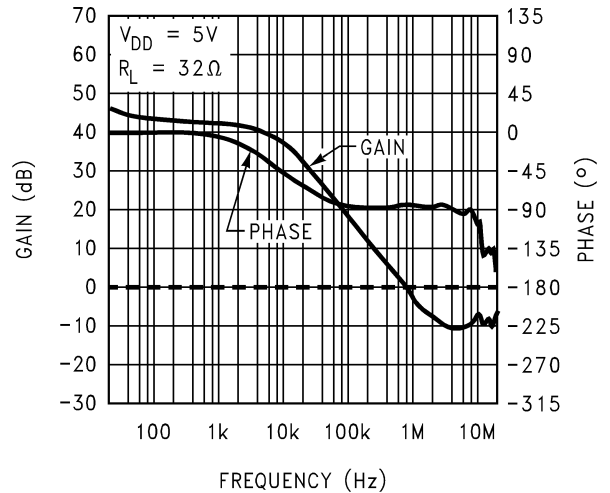
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**Open Loop Frequency Response**



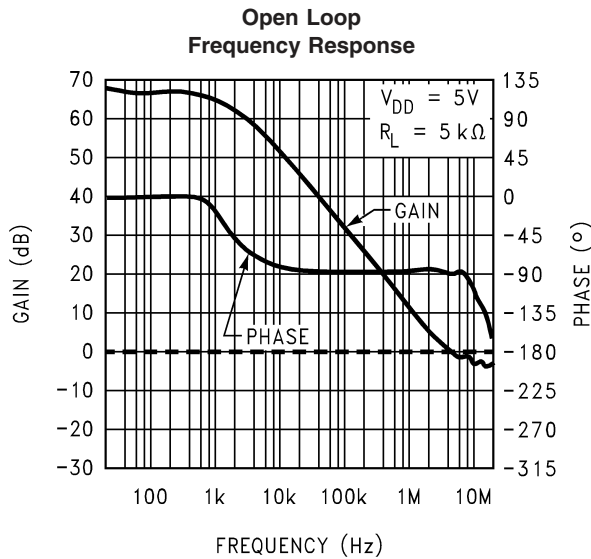
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**Open Loop Frequency Response**

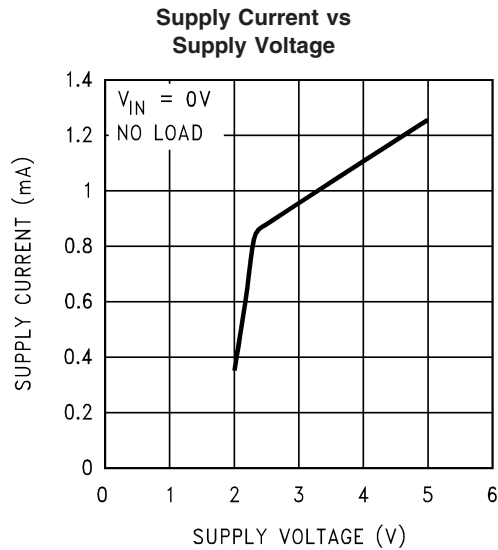


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## Typical Performance Characteristics (Continued)



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## Application Information

### MICRO-POWER SHUTDOWN

The voltage applied to the SHUTDOWN pin controls the LM4810's shutdown function. Activate micro-power shutdown by applying a logic high voltage to the SHUTDOWN pin. The logic threshold is typically  $V_{DD}/2$ . When active, the LM4810's micro-power shutdown feature turns off the amplifier's bias circuitry, reducing the supply current. The low  $0.4\mu A$  typical shutdown current is achieved by applying a voltage that is as near as  $V_{DD}$  as possible to the SHUTDOWN pin. A voltage that is less than  $V_{DD}$  may increase the shutdown current.

There are a few ways to control the micro-power shutdown. These include using a single-pole, single-throw switch, a microprocessor, or a microcontroller. When using a switch, connect an external  $100k\Omega$  pull-up resistor between the SHUTDOWN pin and  $V_{DD}$ . Connect the switch between the SHUTDOWN pin and GND. Select normal amplifier operation by closing the switch. Opening the switch connects the SHUTDOWN pin to  $V_{DD}$  through the pull-up resistor, activating micro-power shutdown. The switch and resistor guarantee that the SHUTDOWN pin will not float. This prevents unwanted state changes. In a system with a microprocessor or a microcontroller, use a digital output to apply the control voltage to the SHUTDOWN pin. Driving the SHUTDOWN pin with active circuitry eliminates the pull-up resistor.

### EXPOSED-DAP PACKAGE PCB MOUNTING CONSIDERATION

The LM4810's exposed-Dap (die attach paddle) package (LD) provides a low thermal resistance between the die and the PCB to which the part is mounted and soldered. This allows rapid heat transfer from the die to the surrounding PCB copper traces, ground plane, and surrounding air.

The LD package should have its DAP soldered to a copper pad on the PCB. The DAP's PCB copper pad may be connected to a large plane of continuous unbroken copper. This plane forms a thermal mass, heat sink, and radiation area.

However, since the LM4810 is designed for headphone applications, connecting a copper plane to the DAP's PCB

copper pad is not required. The LM4810's Power Dissipation vs Output Power Curve in the **Typical Performance Characteristics** shows that the maximum power dissipated is just  $45mW$  per amplifier with a  $5V$  power supply and a  $32\Omega$  load.

Further detailed and specific information concerning PCB layout, fabrication, and mounting an LD (LLP) package is available from National Semiconductor's Package Engineering Group under application note AN1187.

### POWER DISSIPATION

Power dissipation is a major concern when using any power amplifier and must be thoroughly understood to ensure a successful design. Equation 1 states the maximum power dissipation point for a single-ended amplifier operating at a given supply voltage and driving a specified output load.

$$P_{DMAX} = (V_{DD})^2 / (2\pi^2 R_L) \quad (1)$$

Since the LM4810 has two operational amplifiers in one package, the maximum internal power dissipation point is twice that of the number which results from Equation 1. Even with the large internal power dissipation, the LM4810 does not require heat sinking over a large range of ambient temperature. From Equation 1, assuming a  $5V$  power supply and a  $32\Omega$  load, the maximum power dissipation point is  $40mW$  per amplifier. Thus the maximum package dissipation point is  $80mW$ . The maximum power dissipation point obtained must not be greater than the power dissipation that results from Equation 2:

$$P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA} \quad (2)$$

For package MUA08A,  $\theta_{JA} = 210^\circ C/W$ .  $T_{JMAX} = 150^\circ C$  for the LM4810. Depending on the ambient temperature,  $T_A$ , of the system surroundings, Equation 2 can be used to find the maximum internal power dissipation supported by the IC packaging. If the result of Equation 1 is greater than that of Equation 2, then either the supply voltage must be de-

## Application Information (Continued)

creased, the load impedance increased or  $T_A$  reduced. For the typical application of a 5V power supply, with a 32Ω load, the maximum ambient temperature possible without violating the maximum junction temperature is approximately 133.2°C provided that device operation is around the maximum power dissipation point. Power dissipation is a function of output power and thus, if typical operation is not around the maximum power dissipation point, the ambient temperature may be increased accordingly. Refer to the **Typical Performance Characteristics** curves for power dissipation information for lower output powers.

### POWER SUPPLY BYPASSING

As with any power amplifier, proper supply bypassing is critical for low noise performance and high power supply rejection. Applications that employ a 5V regulator typically use a 10μF in parallel with a 0.1μF filter capacitors to stabilize the regulator's output, reduce noise on the supply line, and improve the supply's transient response. However, their presence does not eliminate the need for a local 1.0μF tantalum bypass capacitance connected between the LM4810's supply pins and ground. Keep the length of leads and traces that connect capacitors between the LM4810's power supply pin and ground as short as possible. Connecting a 4.7μF capacitor,  $C_B$ , between the BYPASS pin and ground improves the internal bias voltage's stability and improves the amplifier's PSRR. The PSRR improvements increase as the bypass pin capacitor value increases. Too large, however, increases the amplifier's turn-on time. The selection of bypass capacitor values, especially  $C_B$ , depends on desired PSRR requirements, click and pop performance (as explained in the section, **Selecting Proper External Components**), system cost, and size constraints.

### SELECTING PROPER EXTERNAL COMPONENTS

Optimizing the LM4810's performance requires properly selecting external components. Though the LM4810 operates well when using external components with wide tolerances, best performance is achieved by optimizing component values.

The LM4810 is unity-gain stable, giving a designer maximum design flexibility. The gain should be set to no more than a given application requires. This allows the amplifier to achieve minimum THD+N and maximum signal-to-noise ratio. These parameters are compromised as the closed-loop gain increases. However, low gain demands input signals with greater voltage swings to achieve maximum output power. Fortunately, many signal sources such as audio CODECs have outputs of 1V<sub>RMS</sub> (2.83V<sub>P-P</sub>). Please refer to the **Audio Power Amplifier Design** section for more information on selecting the proper gain.

### Input and Output Capacitor Value Selection

Amplifying the lowest audio frequencies requires high value input and output coupling capacitors ( $C_I$  and  $C_O$  in *Figure 1*). A high value capacitor can be expensive and may compromise space efficiency in portable designs. In many cases, however, the speakers used in portable systems, whether internal or external, have little ability to reproduce signals below 150Hz. Applications using speakers with this limited frequency response reap little improvement by using high value input and output capacitors.

Besides affecting system cost and size,  $C_I$  has an effect on the LM4810's click and pop performance. The magnitude of

the pop is directly proportional to the input capacitor's size. Thus, pops can be minimized by selecting an input capacitor value that is no higher than necessary to meet the desired -3dB frequency. Please refer to the **Optimizing Click and Pop Reduction Performance** section for a more detailed discussion on click and pop performance.

As shown in *Figure 1*, the input resistor,  $R_I$  and the input capacitor,  $C_I$ , produce a -3dB high pass filter cutoff frequency that is found using Equation (3). In addition, the output load  $R_L$ , and the output capacitor  $C_O$ , produce a -3dB high pass filter cutoff frequency defined by Equation (4).

$$f_{i-3db} = 1/2\pi R_I C_I \quad (3)$$

$$f_{o-3db} = 1/2\pi R_L C_O \quad (4)$$

Also, careful consideration must be taken in selecting a certain type of capacitor to be used in the system. Different types of capacitors (tantalum, electrolytic, ceramic) have unique performance characteristics and may affect overall system performance.

### Bypass Capacitor Value Selection

Besides minimizing the input capacitor size, careful consideration should be paid to the value of  $C_B$ , the capacitor connected to the BYPASS pin. Since  $C_B$  determines how fast the LM4810 settles to quiescent operation, its value is critical when minimizing turn-on pops. The slower the LM4810's outputs ramp to their quiescent DC voltage (nominally 1/2  $V_{DD}$ ), the smaller the turn-on pop. Choosing  $C_B$  equal to 4.7μF along with a small value of  $C_I$  (in the range of 0.1μF to 0.47μF), produces a click-less and pop-less shutdown function. As discussed above, choosing  $C_I$  no larger than necessary for the desired bandwidth helps minimize clicks and pops.

### OPTIMIZING CLICK AND POP REDUCTION PERFORMANCE

The LM4810 contains circuitry that minimizes turn-on and shutdown transients or "clicks and pop". For this discussion, turn-on refers to either applying the power supply voltage or when the shutdown mode is deactivated. During turn-on, the LM4810's internal amplifiers are configured as unity gain buffers. An internal current source charges up the capacitor on the BYPASS pin in a controlled, linear manner. The gain of the internal amplifiers remains unity until the voltage on the BYPASS pin reaches 1/2  $V_{DD}$ . As soon as the voltage on the BYPASS pin is stable, the device becomes fully operational. During device turn-on, a transient (pop) is created from a voltage difference between the input and output of the amplifier as the voltage on the BYPASS pin reaches 1/2  $V_{DD}$ . For this discussion, the input of the amplifier refers to the node between  $R_I$  and  $C_I$ . Ideally, the input and output track the voltage applied to the BYPASS pin. During turn-on, the buffer-configured amplifier output charges the input capacitor,  $C_I$ , through the input resistor,  $R_I$ . This input resistor delays the charging time of  $C_I$  thereby causing the voltage difference between the input and output that results in a transient (pop). Higher value capacitors need more time to reach a quiescent DC voltage (usually 1/2  $V_{DD}$ ) when charged with a fixed current. Decreasing the value of  $C_I$  and  $R_I$  will minimize the turn-on pops at the expense of the desired -3dB frequency.

Although the BYPASS pin current cannot be modified, changing the size of  $C_B$  alters the device's turn-on time and

## Application Information (Continued)

the magnitude of “clicks and pops”. Increasing the value of  $C_B$  reduces the magnitude of turn-on pops. However, this presents a tradeoff: as the size of  $C_B$  increases, the turn-on time increases. There is a linear relationship between the size of  $C_B$  and the turn-on time. Here are some typical turn-on times for various values of  $C_B$ :

| $C_B$        | $T_{ON}$ |
|--------------|----------|
| 0.1 $\mu$ F  | 80ms     |
| 0.22 $\mu$ F | 170ms    |
| 0.33 $\mu$ F | 270ms    |
| 0.47 $\mu$ F | 370ms    |
| 0.68 $\mu$ F | 490ms    |
| 1.0 $\mu$ F  | 920ms    |
| 2.2 $\mu$ F  | 1.8sec   |
| 3.3 $\mu$ F  | 2.8sec   |
| 4.7 $\mu$ F  | 3.4sec   |
| 10 $\mu$ F   | 7.7sec   |

In order eliminate “clicks and pops”, all capacitors must be discharged before turn-on. Rapidly switching  $V_{DD}$  may not allow the capacitors to fully discharge, which may cause “clicks and pops”. In a single-ended configuration, the output is coupled to the load by  $C_O$ . This capacitor usually has a high value.  $C_O$  discharges through internal 20k $\Omega$  resistors. Depending on the size of  $C_O$ , the discharge time constant can be relatively large. To reduce transients in single-ended mode, an external 1k $\Omega$ –5k $\Omega$  resistor can be placed in parallel with the internal 20k $\Omega$  resistor. The tradeoff for using this resistor is increased quiescent current.

### AUDIO POWER AMPLIFIER DESIGN

#### Design a Dual 70mW/32 $\Omega$ Audio Amplifier

Given:

|                 |                            |
|-----------------|----------------------------|
| Power Output    | 70 mW                      |
| Load Impedance  | 32 $\Omega$                |
| Input Level     | 1 Vrms (max)               |
| Input Impedance | 20k $\Omega$               |
| Bandwidth       | 100 Hz–20 kHz $\pm$ 0.50dB |

The design begins by specifying the minimum supply voltage necessary to obtain the specified output power. One way to find the minimum supply voltage is to use the Output Power vs Supply Voltage curve in the **Typical Performance Characteristics** section. Another way, using Equation (5), is to calculate the peak output voltage necessary to achieve the desired output power for a given load impedance. To account for the amplifier’s dropout voltage, two additional voltages, based on the Dropout Voltage vs Supply Voltage in the **Typical Performance Characteristics** curves, must be added to the result obtained by Equation (5). For a single-ended application, the result is Equation (6).

$$V_{\text{opeak}} = \sqrt{(2R_L P_O)} \quad (5)$$

$$V_{DD} \geq (2V_{\text{OPEAK}} + (V_{\text{ODTOP}} + V_{\text{ODBOT}})) \quad (6)$$

The Output Power vs Supply Voltage graph for a 32 $\Omega$  load indicates a minimum supply voltage of 4.8V. This is easily met by the commonly used 5V supply voltage. The additional voltage creates the benefit of headroom, allowing the LM4810 to produce peak output power in excess of 70mW without clipping or other audible distortion. The choice of supply voltage must also not create a situation that violates maximum power dissipation as explained above in the **Power Dissipation** section. Remember that the maximum power dissipation point from Equation (1) must be multiplied by two since there are two independent amplifiers inside the package. Once the power dissipation equations have been addressed, the required gain can be determined from Equation (7).

$$A_V \geq \sqrt{(P_O R_L)} / (V_{IN}) = V_{\text{orms}} / V_{\text{inrms}} \quad (7)$$

Thus, a minimum gain of 1.497 allows the LM4810 to reach full output swing and maintain low noise and THD+N performance. For this example, let  $A_V = 1.5$ .

The amplifiers overall gain is set using the input ( $R_i$ ) and feedback ( $R_f$ ) resistors. With the desired input impedance set at 20k $\Omega$ , the feedback resistor is found using Equation (8).

$$A_V = R_f / R_i \quad (8)$$

The value of  $R_f$  is 30k $\Omega$ .

The last step in this design is setting the amplifier’s –3dB frequency bandwidth. To achieve the desired  $\pm 0.25$ dB pass band magnitude variation limit, the low frequency response must extend to at least one-fifth the lower bandwidth limit and the high frequency response must extend to at least five times the upper bandwidth limit. The gain variation for both response limits is 0.17dB, well within the  $\pm 0.25$ dB desired limit. The results are an

$$f_L = 100\text{Hz} / 5 = 20\text{Hz} \quad (9)$$

and a

$$f_H = 20\text{kHz} * 5 = 100\text{kHz} \quad (10)$$

As stated in the **External Components** section, both  $R_i$  in conjunction with  $C_i$ , and  $C_o$  with  $R_L$ , create first order high-pass filters. Thus to obtain the desired low frequency response of 100Hz within  $\pm 0.5$ dB, both poles must be taken into consideration. The combination of two single order filters at the same frequency forms a second order response. This results in a signal which is down 0.34dB at five times away from the single order filter –3dB point. Thus, a frequency of 20Hz is used in the following equations to ensure that the response is better than 0.5dB down at 100Hz.

$$C_i \geq 1 / (2\pi * 20\text{k}\Omega * 20\text{Hz}) = 0.397\mu\text{F}; \text{ use } 0.39\mu\text{F}. \quad (11)$$

$$C_o \geq 1 / (2\pi * 32\Omega * 20\text{Hz}) = 249\mu\text{F}; \text{ use } 330\mu\text{F}. \quad (12)$$

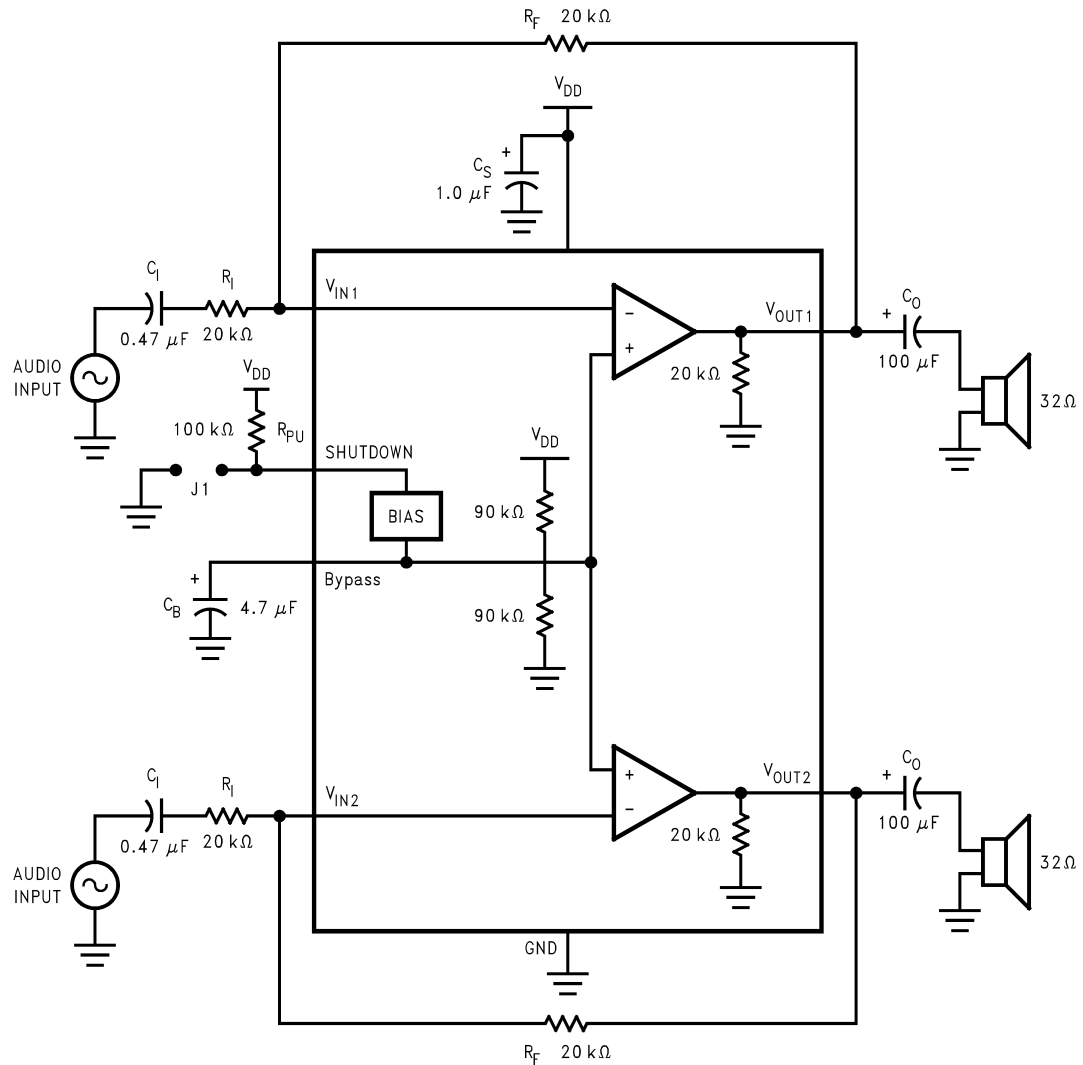
The high frequency pole is determined by the product of the desired high frequency pole,  $f_H$ , and the closed-loop gain,

## Application Information (Continued)

$A_V$ . With a closed-loop gain of 1.5 and  $f_H = 100\text{kHz}$ , the resulting GBWP = 150kHz which is much smaller than the LM4810's GBWP of 900kHz. This figure displays that if a

designer has a need to design an amplifier with a higher gain, the LM4810 can still be used without running into bandwidth limitations.

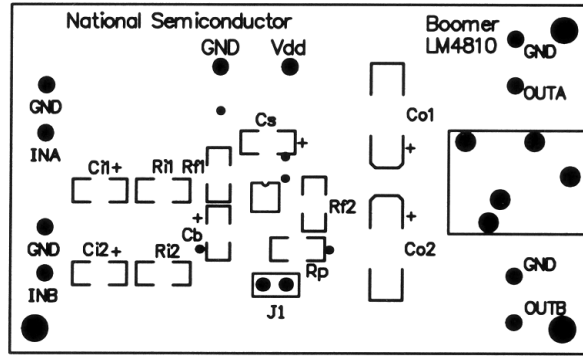
## Demonstration Board Schematic



20008959

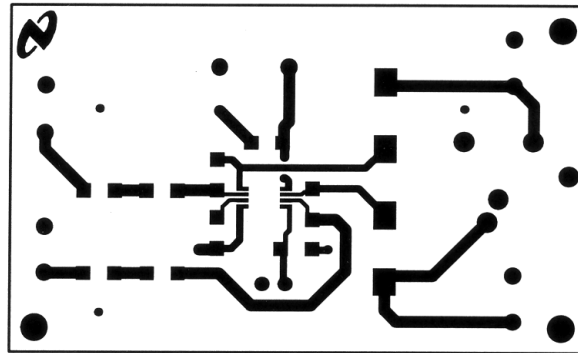
FIGURE 2. LM4810 Demonstration Board Schematic

# Demonstration Board Layout



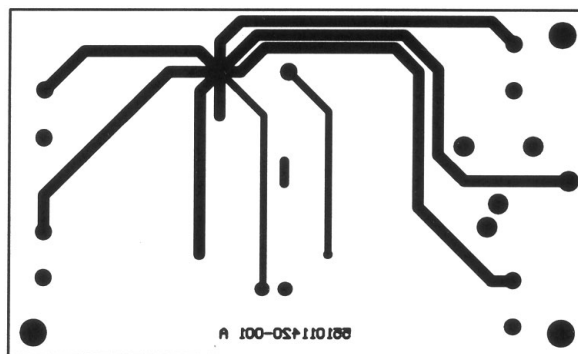
20008960

FIGURE 3. Recommended PC Board Layout Component-Side Silkscreen



20008961

FIGURE 4. Recommended PC Board Layout Component-Side Layout

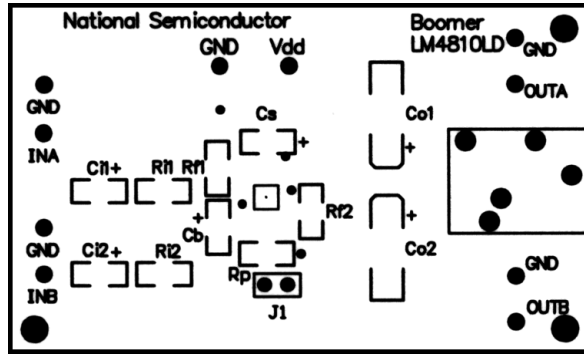


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FIGURE 5. Recommended PC Board Layout Bottom-Side Layout

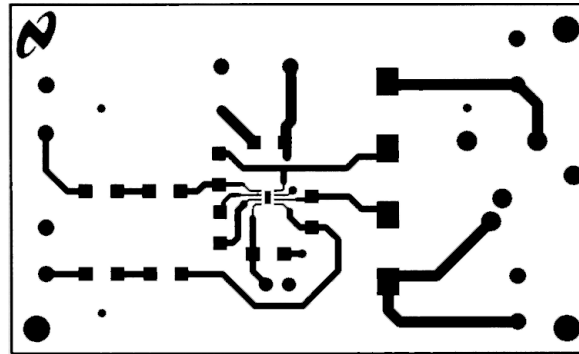


Demonstration Board Layout (Continued)



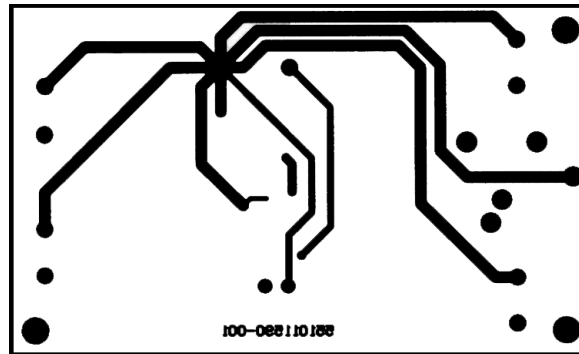
20008987

FIGURE 6. Recommended LD PC Board Layout Component-Side Silkreen



20008988

FIGURE 7. Recommended LD PC Board Layout Component-Side Layout

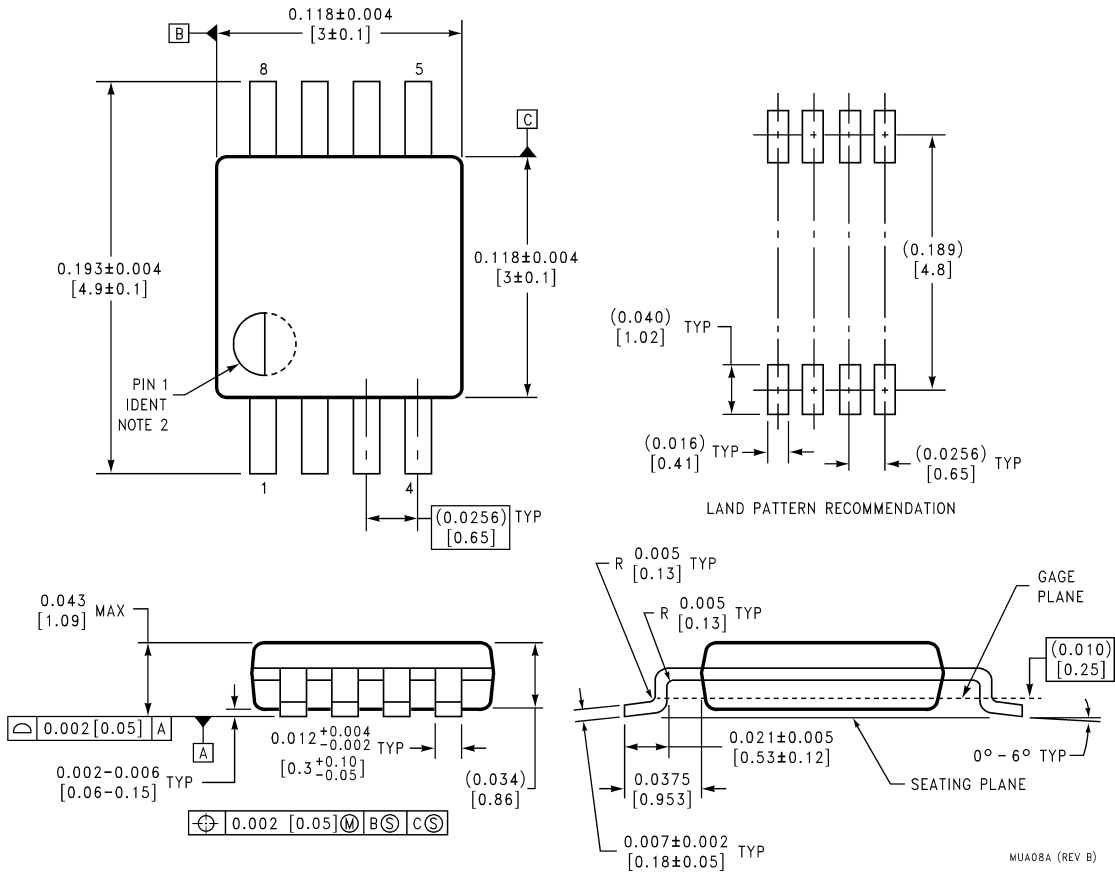


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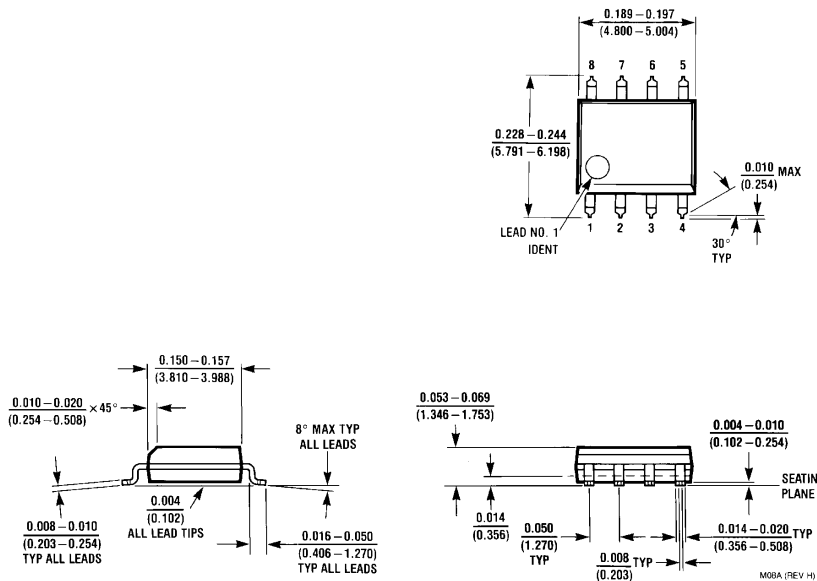
FIGURE 8. Recommended LD PC Board Layout Bottom-Side Layout



**Physical Dimensions** inches (millimeters) unless otherwise noted

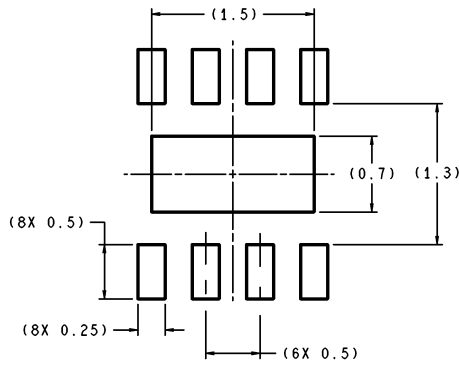


**Order Number LM4810MM**  
**NS Package Number MUA08A**



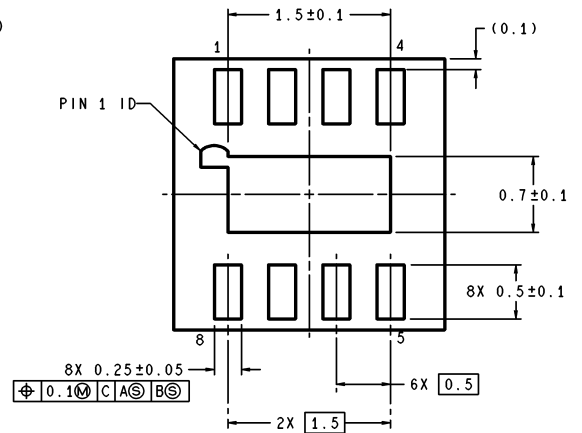
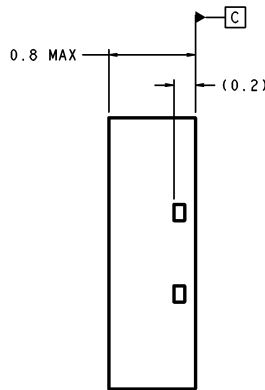
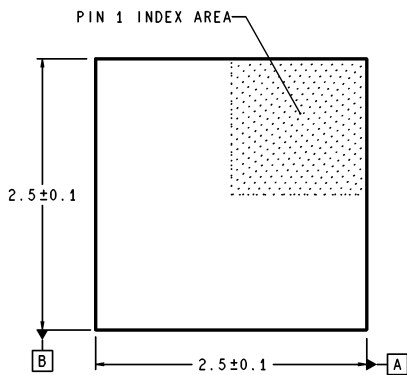
**Order Number LM4810MA**  
**NS Package Number M08A**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



DIMENSIONS ARE IN MILLIMETERS

RECOMMENDED LAND PATTERN  
1:1 RATIO WITH PKG SOLDER PADS



LDA08B (Rev A)

Order Number LM4810LD  
NS Package Number LDA08B

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